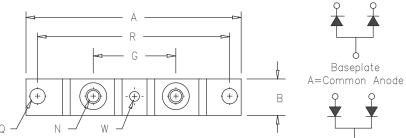
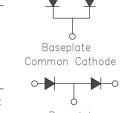
Schottky PowerMod

Baseplate





Baseplate D=Doubler Notes:

Baseplate: Nickel plated copper

Dim. In	ches	Millimeters		
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490 G 1.375 H 0.050 N Q 0.275 R 3.150	.680 0.130 0.510 BSC 0.290 BSC 0.340	3.05 12.45 34.92 1.25 6.99 80.01 15.24 7.92	12.95 2 BSC 7.37 1 BSC 8.64	1/4-20 Dia.

Microsemi	Industry	Working Peak	Repetitive Peak
Catalog Number	Part Number	Reverse Voltage	Reverse Voltage

CPT600120* 120V 120V CPT600150* 150V 150V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard ring protection
- 600 Amperes/ 120 to 150 Volts
- 175°C junction temperature
- Reverse energy tested
- ROHS Compliant

Electrical Characteristics

|F(AV) 600 Amps Average forward current per pkg Average forward current per leg Maximum surge current per leg Maximum repetitive reverse current per leg ^IR(OV) 2 Amps
Max peak forward voltage per lea VFM 0.85 Volt Max peak forward voltage per leg V_{FM} Max peak forward voltage per leg 1_{RM} Max peak reverse current per leg ^IRM Max peak reverse current per leg Typical junction capacitance per leg

(AV) 300 Amps FSM 6000 Amps 0.85 Volts 0.62 Volts 75 mA 7.0 mA 7000 pF

 T C = 132°C, Square wave, R OJC = 0.10°C/W T C = 132°C, Square wave, R OJC = 0.20°C/W 8.3ms, half sine, T J = 175°C

f = 1 KHZ, 25°C, 1µsec square wave |FM = 300A:TJ = 25°C |FM = 300A:TJ = 175°C

 $VRRM, TJ = 125^{\circ}C^{*}$ $VRRM,^TJ = 25^{\circ}C$ $V_R = 5.0V, T_C = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range Operating junction temp range Max thermal resistance per leg Max thermal resistance per pkg Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

TSTG -55℃ to 175℃ ΤJ -55°C to 175°C R OJC 0.20°C/W Junction to case R OJC 0.10°C/W Junction to case 0.08°C/W Case to sink Recs 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



CPT600120 - CPT600150

Figure 1 Typical Forward Characteristics — Per Leg

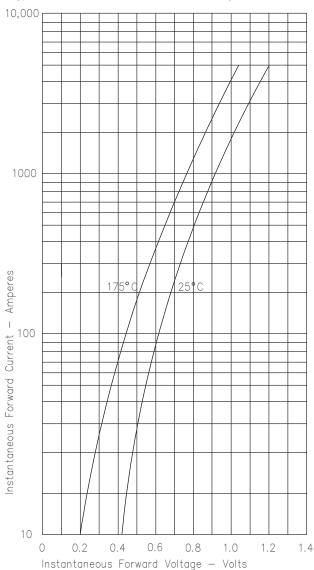


Figure 2 Typical Reverse Characteristics — Per Leg

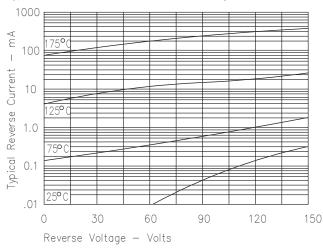


Figure 3 Typical Junction Capacitance — Per Leg

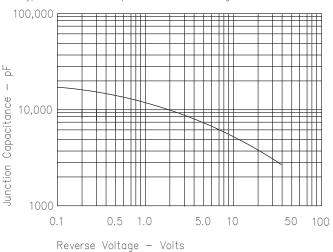


Figure 4
Forward Current Derating — Per Leg

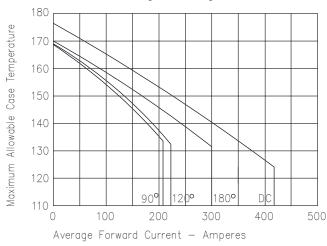
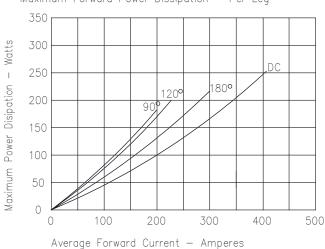


Figure 5

Maximum Forward Power Dissipation — Per Leg





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